

PACSR48006

48V Output AC/DC Converter, Module Package



FEATURES

- Full Load Efficiency up to 93.5% @220VAC
- Metal Case Box Type Package
- Package Dimension:
- 110.8x50.8x13.7mm (4.33"x2.00"x0.54")
- Operating Baseplate Temperature Range 40°C to +100°C
- Input Brown-Out, Output OCP, OTP, OVP, SHORT protection
- 3000VAC Isolation
- RoHS Compliant
- CE Mark
- EMC compatible: CISPR11 ClassB(with external EMC filter)
- ISO 9001, ISO 14001 certified manufacturing facility
- UL/cUL 60950-1 (US & Canada)
- Surge immunity(with external EMC filter):
 AC: ±1 kV differential mode
 AC: ±2 kV common mode

The PACSR48006, a wide input voltage range of 85~265VAC, and single isolated output converter, is the latest product offering from a world leader in power systems technology and manufacturing — Delta Electronics, Inc. Such module type ACDC converter can provide 300W, 48V regulated DC output voltage with full load efficiency up to 93.5% @220Vac; the PACSR48006 offers Brown-out, output OCP, OTP, OVP and Short protections, and allows a wide operating baseplate temperature range of -40°C to +100°C. With creative design technology and optimization of component placement, this converter possess outstanding electrical and thermal performance, as well as high reliability under extremely harsh operating conditions.

(All specifications valid base on the connection of figure 10, unless otherwise indicated)

| Input Characteristics | | | | | |
|-----------------------------------------|----------------------------------------------------------------------|------|---------|------|------|
| Item | Condition | Min. | Тур. | Max. | Unit |
| Rated input voltage range | | 100 | 110/220 | 240 | VAC |
| Max input voltage range | | 85 | | 265 | VAC |
| Input voltage frequency range | | 45 | 50/60 | 65 | Hz |
| Maximum Input Current | Vin=85VAC, 100% Load | | | 4.2 | А |
| Input PF value | Vin=110VAC, 100% Load | 0.95 | | | |
| Allowable bus capacitance range Note(1) | Vin=110/220VAC 100% Load | 440 | | 1000 | uF |
| Output Characteristics | | | | | |
| Item | Conditions | Min. | Тур. | Max. | Unit |
| PG high | Good state | 3.0 | 3.2 | 3.4 | V |
| PG low | Fault state | 0 | | 0.8 | V |
| PG delay time | Vbus=0V,Vin >75V to PG signal >1V | | | 2500 | ms |
| PG source current | PG high | | | +0.3 | mA |
| PG sink current | PG low | | | -0.3 | mA |
| Output voltage setpoint | Vin=220VAC, Io=0-6.3A | 47.5 | 48 | 48.5 | Vdc |
| Output current range | | 0 | | 6.3 | A |
| Output OCP point | | 7 | 8 | 9.4A | A |
| Turn-on rise time | | | 15 | | ms |
| Start up time | Vin=110/220VAC | | 1500 | | mS |
| Hold up time | Vin=110/220VAC, Io= 100% Load | | 20 | | mS |
| Output OVP point | | 53.5 | 56 | 58.5 | V |
| | Positive voltage step, 75% to 25% load dynamic, 0.1A/us slew rate | | 400 | 800 | mV |
| Output Current Transient | Nagetive voltage step, 25% to 75% load dynamic, 0.1A/us slew rate | | 400 | 800 | mV |



| Output Voltage Ripple and Noise | Vin=110/220Vac, Io=6.3A, peak to peak, 20MHz bandwidth | | 100 | | mV |
|--------------------------------------------|-----------------------------------------------------------|------|------|------|--------|
| | RMS | | 60 | | mV |
| Output overshoot | | | | 3 | % |
| Efficiency @ 60% Load | Vin=110VAC | | 91 | | % |
| Efficiency @ 60% Load | Vin=220VAC | | 92 | | % |
| Efficiency @ 100% Load | Vin=110VAC | | 92 | | % |
| Efficiency @ 100% Load | Vin=220VAC | | 93.5 | | % |
| Allowable output capacitance range Note(2) | Vin=110/220VAC, Io= 100% Load | 400 | | 2000 | uF |
| General Characteristics | | | | | |
| Item | Conditions | Min. | Тур. | Max. | Unit |
| | Input to output | | 3000 | | VAC |
| I/O Isolation Voltage | Input to case | | 1500 | | VAC |
| | Output to case | | 500 | | VAC |
| I/O Isolation Resistance | 500Vdc | 10 | | | MΩ |
| MTBF | Ta=25°C,normal input,100% load | | 1.2 | | Mhours |
| Weight | | | 225 | | g |
| Environmental Specificat | ions | | | | |
| Parameter | Conditions | Min. | | Max. | Unit |
| Storage Temperature Range | | -55 | | +125 | °C |
| Operating Temperature Range | Plate Temperature | -40 | | +100 | °C |
| Operating altitude | | | | 3000 | meter |
| TCT cycle Note(3) | | | | | |
| THB cycle Note(4)(5) | | | | | |

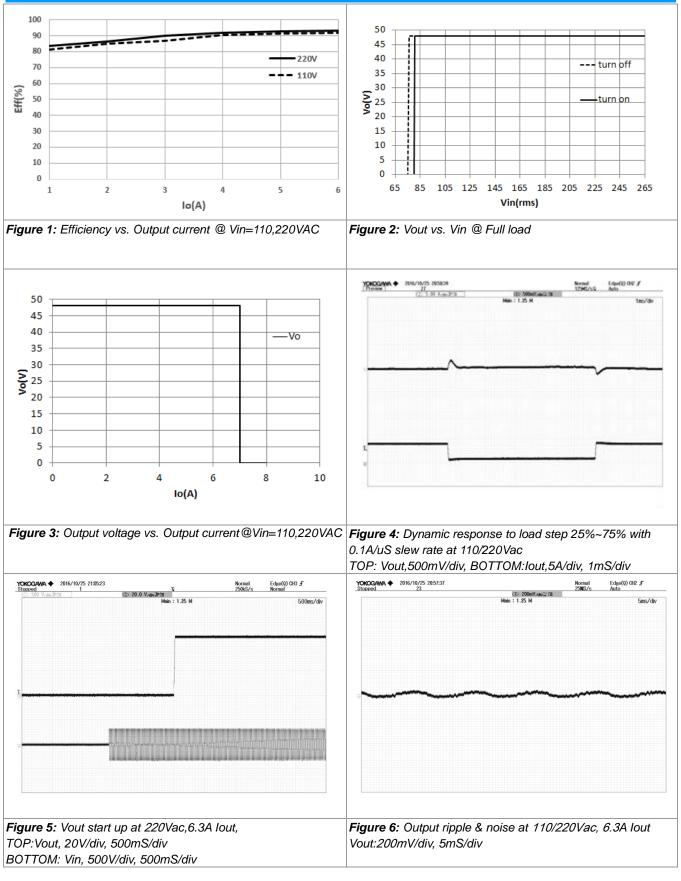
==Note==

- (1) About the bus cap., please find details in section "SIMPLIFIED APPLICATION CIRCUIT".
- (2) About the min. and max. output cap., please find details in section "SIMPLIFIED APPLICATION CIRCUIT".
- (3) The testing conditions of TCT cycle are as follows:
 - 1.1 Temperature Range: -40°C±3°C ~125°C±3°C
 - 1.2 Dwell time: 30min
 - 1.3 Ramp rate: 20°C/min.
 - 1.4 Cycling: 200 cycles
 - 1.5 Units shall be unpowered
- (4) The THB test starts with a pre-conditioning soak of all units for 72hrs under the following conditions:
 - 2.1 Unpowered
 - 2.2 Ambient temperature: 85° C
 - 2.3 Relative humidity: 85%
- (5) The THB Testing is performed for 1000hrs under the following conditions:
 - 3.1 Input Voltage: Maximum Voltage
 - 3.2 Output Load: Minimum load
 - 3.3 Ambient temperature: The max rated ambient temperature or 85° C, whichever is less.
 - 3.4 Relative humidity: 85%

*Specifications are subject to change without notice



ELECTRICAL CURVES

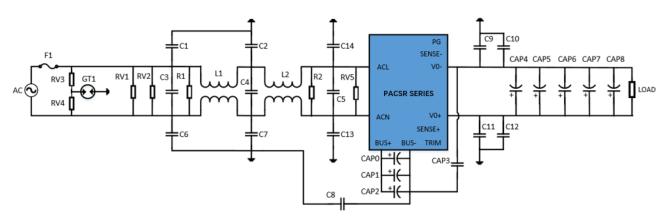




| Image: 12.5 H State State | TOKOGAWA 2016/10/25 21:13:24 Stopped 1 | ③ 10.0 V∠div⊒M⊡ 10.0 V∠div⊒M⊡ | Normal 250kS/s | Edge(Q) CH4 飞 Auto | YOKOGAWA ◆ 2015/09/17 14:06:15 Preview II IZ 10.0 Axiev Inter | | Normal 2.5MS/s | Edge CH2 72.6.7 A Auto |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------|----------------------------------|-------------------|-----------------------|---------------------------------------------------------------------------------------------------------------------------|----------------|-------------------|---------------------------|
| ut: 10V/div, 500mS/div | | | | | | | | |
| | 7 | | | | | | | |
| | ut: 10V/div, 500mS/div | | Rend | Auto | Figure 8: Inrush currer | nt @ Vin=220Va | c lin:10A/ | /div, 5mS/d |



SIMPLIFIED APPLICATION CIRCUIT



Note: PACSR series does not support parallel application

Figure 10: Application connection

| No | Location | Item | Value | Part Number |
|----|----------|-----------------|---------------------|------------------------------------------------------------------------------------|
| 1 | Cap0 | Bus cap | 220uF/450V | Capacitor should have good |
| 2 | Cap1 | Bus cap | 220uF/450V | low-temperature characteristics, keep at least 75% capacitance at -40°C if need |
| 3 | Cap2 | Bus cap | 220uF/450V | -40°C application. Note(6) |
| 4 | Cap3 | Cap for pri-sec | 2200pF/250Vac Y1/X1 | |
| 5 | Cap4 | Output cap | 470uF/63V | ESR≪16m Ω (100kHz), Rated ripple≥ 2920mArms(105°C) ^{Note(7)} |
| 6 | Cap5 | Output cap | 100uF/63V | |
| 7 | Cap6 | Output cap | 100uF/63V | ESR \leq 17m Ω (100kHz), Rated ripple \geq |
| 8 | Cap7 | Output cap | 100uF/63V | 2200mArms(125°C) ^{Note(8)} |
| 9 | Cap8 | Output cap | 100uF/63V | |
| 10 | F1 | Input Fuse | 10A/250Vac | |
| 11 | RV1 | Input VDR | 300VAC | TVR14471KOOOTB9Y/THINKING |
| 12 | RV2 | Input VDR | 300VAC | TVR14471KOOOTB9Y/THINKING |
| 13 | RV3 | Input VDR | 300VAC | TVR14471KOOOTB9Y/THINKING |
| 14 | RV4 | Input VDR | 300VAC | TVR14471KOOOTB9Y/THINKING |
| 15 | RV5 | Input VDR | 300VAC | TVR14471KOOOTB9Y/THINKING |
| 16 | GT1 | Input GAS TUBE | 2.5KV/10KA | B88069X8661S102(EF2500X8S) |
| 17 | C1 | Input Y-cap | 100pF/250Vac Y2/X1 | |
| 18 | C2 | Input Y-cap | 4700pF/250Vac Y2/X1 | |
| 19 | C3 | Input X-cap | 1uF /305VAC X2 | |
| 20 | C4 | Input X-cap | 0.47uF /275VAC X2 | |
| 21 | C5 | Input X-cap | 0.47uF /275VAC X2 | |
| 22 | C6 | Input Y-cap | 100pF/250Vac Y2/X1 | |
| 23 | C7 | Input Y-cap | 4700pF/250Vac Y2/X1 | |
| 24 | C8 | Cap for pri-PE | 1500pF/250Vac Y1/X1 | |
| 25 | С9 | Output Y-cap | 4700pF/250Vac Y2/X1 | |
| 26 | C10 | Output Y-cap | 4700pF/250Vac Y2/X1 | |
| 27 | C11 | Output Y-cap | 4700pF/250Vac Y2/X1 | |
| 28 | C12 | Output Y-cap | 4700pF/250Vac Y2/X1 | |
| 29 | C13 | Input Y-cap | 100pF/250Vac Y2/X1 | |



| 30 | C14 | Input Y-cap | 100pF/250Vac Y2/X1 | |
|----|-----|-------------|--------------------|--|
| 31 | L1 | Input chock | 11mH ф1mm | |
| 32 | L2 | Input chock | 11mH ф1mm | |
| 33 | R1 | Input RES | 1/4W 820Kohm | |
| 34 | R2 | Input RES | 1/4W 820Kohm | |

*read the Application Note for this module carefully before using the power supply unit

==Note==

(1) and (6): About the bus cap., please read the Application Note about the hold up time configure.
(2) and (8): About the min. output cap., please use the cap. which has more performance than the cap. in the table above, or refer the cap. about the output cap. ability in the Application Note. (2) and (7): About the max. output cap., please follow the Application Note about the output cap. ability.



THERMAL CONSIDERATION

Thermal management is an important part of the system design. To ensure proper, reliable operation, sufficient cooling of the power module is needed over the entire temperature range of the module. Conduction cooling is usually the dominant mode of heat transfer.

Thermal Testing Setup

The following figure shows the testing setup in which the power mudule is mounted on an AI plate and was cooled by cooling liquid.

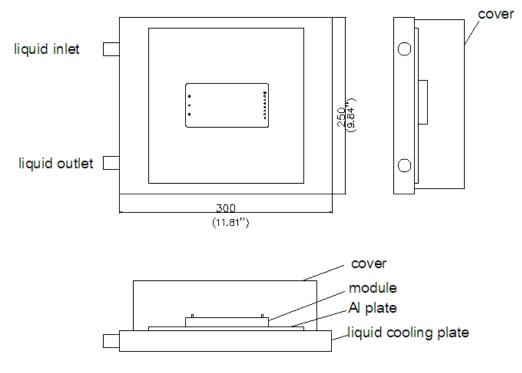


Figure 11: Thermal test setup



THERMAL DERATING CURVE

The following figure shows the location to monitor the temperature of the module's baseplate. The baseplate temperature in thermal curve is a reference for customer to make thermal evaluation and make sure the module is operated under allowable temperature. (Thermal curves shown in Figure12 are based on different input voltage).

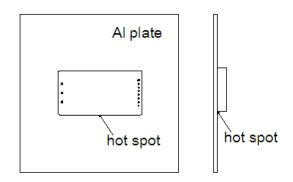


Figure 12: Baseplate's temperature measured point

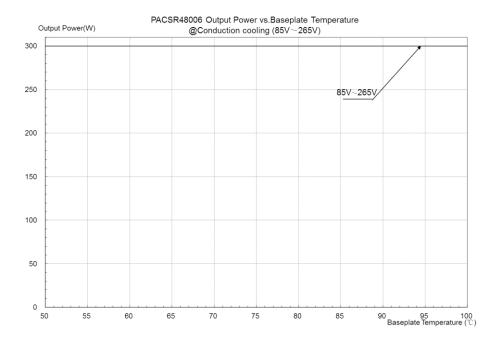
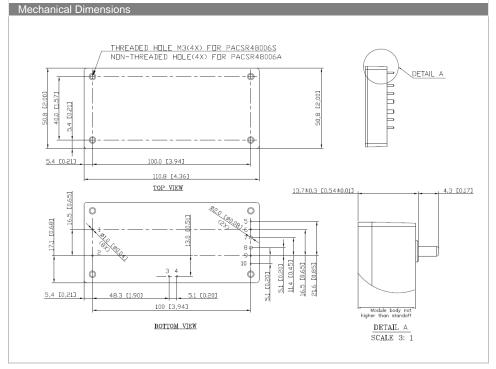


Figure 13: Thermal derating curves



MECHANICAL DRAWING



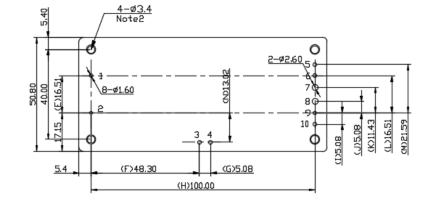
| Pin Conne | ection |
|-----------|----------|
| Pin | Function |
| 1 | ACL |
| 2 | ACN |
| 3 | BUS+ |
| 4 | BUS- |
| 5 | PG |
| 6 | SENSE- |
| 7 | VOUT- |
| 8 | VOUT+ |
| 9 | SENSE+ |
| 10 | NC |

All dimensions in mm (inches) Tolerance:X.X±0.5 (X.XX±0.02)

X.XX±0.25 (X.XXX±0.010)

RECOMMENDED P.W.B PAD LAYOUT

RECOMMENDED P.W.B. PAD LAYOUT



| PIN # | FUNCTION | D_PIN |
|-------|----------|-------|
| 1 | ACL | Ø1.00 |
| 2 | ACN | Ø1.00 |
| 3 | Bus+ | ¢1.00 |
| 4 | Bus- | ¢1.00 |
| 5 | 5 PG | |
| 6 | Sense- | ø1.00 |
| 7 | Vout- | ø2.00 |
| 8 | Vout+ | ø2.00 |
| 9 | 9 Senset | |
| 10 | NC | Ø1.00 |

NDTE1

FOR MODULES WITH THROUGH-HOLE PINS AND THE OPTIONAL HEAT SPREADER, THEY ARE INTENDED FOR WAVE SOLDERING ASSEMBLY ON TO SYSTEM BOARDS. PLEASE DO NOT SUBJECT SUCH MODULES THROUGH REFLOW TEMPERATURE PROFILE.

NDTE2

AT THESE FOUR HOLES POSITION, IT SHOULD USE SCREWS TO FIX THE POWER MODULE ON CUSTOMER SYSTEM BOARD.



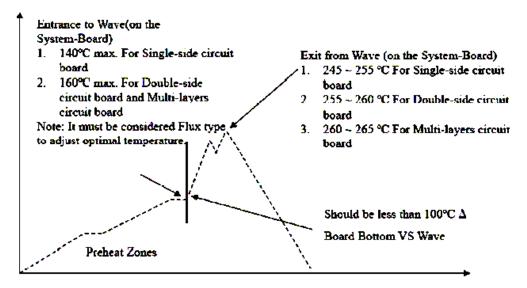
SOLDERING METHOD

Generally, as the most common mass soldering method for the solder attachment, wave soldering is used for through-hole power modules and reflow soldering is used for surface-mount ones. Delta recommended soldering methods and process parameters are provided in this document for solder attachment of power modules onto system board. SAC305 is the suggested lead-free solder alloy for all soldering methods. The soldering temperature profile presented in this document is based on SAC305 solder alloy.

Reflow soldering is not a suggested method for through-hole power modules due to many process and reliability concerns. If you have this kind of application requirement, please contact Delta sales or FAE for further confirmation.

Wave Soldering (Lead-free)

Delta's power modules are designed to be compatible with single-wave or dual wave soldering. The suggested soldering process must keep the power module's internal temperature below the critical temperature of 217°C continuously. The recommended wave-soldering profile is shown below:



Note: The temperature is measured on solder joint of pins of power module.

The typical recommended (for double-side circuit board) preheat temperature is $115+/-10^{\circ}$ C on the top side (component side) of the circuit board. The circuit-board bottom-side preheat temperature is typically recommended to be greater than 135° C and preferably within 100° C of the solder-wave temperature. A maximum recommended preheat up rate is 3° C /s. A maximum recommended solder pot temperature is $255+/-5^{\circ}$ C with solder-wave dwell time of $3\sim6$ seconds. The cooling down rate is typically recommended to be 6 °C/s maximum.



Hand Soldering (Lead Free)

Hand soldering is the least preferred method because the amount of solder applied, the time the soldering iron is held on the joint, the temperature of the iron, and the temperature of the solder joint are variable. The recommended hand soldering guideline is listed in Table below. The suggested soldering process must keep the power module's internal temperature below the critical temperature of 217°C continuously.

| Parameter | Single-side | Double-side | Multi-side |
|------------------------|----------------------|------------------------|------------------------|
| | Circuit Board | Circuit Board | Circuit Board |
| Soldering Iron Wattage | 90₩ | 90₩ | 90₩ |
| Tip Temperature | 385+/-10℃ | 420+/−10℃ | 420+/-10℃ |
| Soldering Time | 2 \sim 6 seconds | 4 $^{\sim}$ 10 seconds | 4 $^{\sim}$ 10 seconds |

| Physical | | | (4.00%-0.00%-0.54) | 2 | | | | | |
|----------------------------|------------------------------------------------------------------------------------------|----------------------|--------------------|----------------|-------------------|-------------|--|--|--|
| Case Size Case Material | Case Size : 110.8x50.8x13.7mm (4.33"x2.00"x0.54") Case Material : AL6061+Plastic case | | | | | | | | |
| Weight | : 22 | 25g | | | | | | | |
| Part Num | Part Numbering System | | | | | | | | |
| Р | AC | S | R | 48 | 006 | А | | | |
| Form Factor | Rated Input Voltage | Number of Outputs | Product Series | Output Voltage | Output Current | Option Code | | | |

| Model List | | | · · · · · · · · · · · · · · · · · · · | | |
|-------------|---------------|------|---------------------------------------|------|--------------------------|
| Model Name | Rated In | put | Output | | EFF @220VAC 100% LOAD |
| PACSR48006A | 100VAC~240VAC | 5.8A | 48V | 6.3A | 93.5% |
| PACSR48006S | 100VAC~240VAC | 5.8A | 48V | 6.3A | 93.5% |

48V

0-6.3A

R - Regular

WARRANTY

P-Module

AC -

100VAC~240VAC

S - Single

Delta offers a two (2) years limited warranty. Complete warranty information is listed on our web site or is available upon request from Delta.

Information furnished by Delta is believed to be accurate and reliable. However, no responsibility is assumed by Delta for its use, nor for any infringements of patents or other rights of third parties, which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Delta. Delta reserves the right to revise these specifications at any time, without notice.

A - Through hole

S - Screw hole(M3*0.5)

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